

TS2012

Filter-free stereo 2x2.8 W class D audio power amplifier



Datasheet - production data

Features

- Operating range from V_{CC} = 2.5 V to 5.5 V
- Standby mode active low
- Output power per channel: 1.35 W @ 5 V or 0.68 W @ 3.6 V into 8 Ω with 1 % THD+N max
- Output power per channel: 2.2 W @ 5 V into 4 Ω with 1 % THD+N max
- Four gains can be selected: 6, 12, 18, 24 dB
- Low current consumption
- PSRR: 70 dB typ @ 217 Hz with 6 dB gain
- Fast startup phase: 1 ms
- Thermal shutdown protection
- QFN20 4x4 mm lead-free package

Applications

- Cellular phone
- PDA
- Flat panel TV

Description

The TS2012 is a fully differential, class D, power amplifier stereo. It is able to drive up to 1.35 W into an 8 Ω load at 5 V per channel. It achieves outstanding efficiency compared to typical class AB audio amps.

The device has four different gain settings utilizing two discrete pins: G0 and G1.

Pop and click reduction circuitry provides low on/off switch noise while allowing the device to start within 1 ms.

Two standby pins (active low) allow each channel to be switched off independently.

The TS2012 is available in a QFN20 4x4 mm package.

This is information on a product in full production.

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TS2012



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Absolute maximum ratings and operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage ⁽¹⁾	6	v
Vi	Input voltage ⁽²⁾	GND to V _{CC}	v
T _{oper}	Operating free air temperature range	-40 to + 85	
T _{stg}	Storage temperature	-65 to +150	°C
Тj	Maximum junction temperature	150	
R _{thja}	Thermal resistance junction to ambient ⁽³⁾	100	°C/W
Pd	Power dissipation	Internally limited ⁽⁴⁾	
ESD	HBM: human body model ⁽⁵⁾	2	kV
ESD	MM: machine model ⁽⁶⁾	200	V
Latch-up	Latch-up immunity	200	mA
V _{STBY}	Standby pin voltage maximum voltage	GND to V _{CC}	V
	Lead temperature (soldering, 10 s)	260	°C

Table 1. Absolute maximum ratings

1. All voltage values are measured with respect to the ground pin.

2. The magnitude of the input signal must never exceed V_{CC} + 0.3 V / GND - 0.3 V.

3. The device is protected in case of over temperature by a thermal shutdown active @ 150 °C.

4. Exceeding the power derating curves over a long period causes abnormal operation.

- 5. Human body model: 100 pF discharged through a 1.5 k Ω resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
- 6. Machine model: a 200 pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω), done for all couples of pin combinations with other pins floating.



Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	2.5 to 5.5	
VI	Input voltage range	GND to V _{CC}	
V _{ic}	Input common mode voltage ⁽¹⁾	GND+0.5V to V _{CC} -0.9V	V
V _{STBY}	Standby voltage input ⁽²⁾ Device ON Device in STANDBY ⁽³⁾	$1.4 \le V_{STBY} \le V_{CC}$ GND $\le V_{STBY} \le 0.4$	
RL	Load resistor	≥ 4	Ω
V _{IH}	GO, G1 - high level input voltage ⁽⁴⁾	$1.4 \le V_{IH} \le V_{CC}$	V
V _{IL}	GO, G1 - low level input voltage	$GND \le V_{IL} \le 0.4$	v
R _{thja}	Thermal resistance junction to ambient ⁽⁵⁾	40	°C/W

Table 2. Operating conditions

1. I V_{oo} I \leq 40 mV max with all differential gains except 24 dB. For 24 dB gain, input decoupling caps are mandatory.

2. Without any signal on V_{STBY}, the device is in standby (internal 300 k Ω ± 20 % pull-down resistor).

3. Minimum current consumption is obtained when V_{STBY} = GND.

 Between G0, G1pins and GND, there is an internal 300kΩ(±20 %) pull-down resistor. When pins are floating, the gain is 6 dB. In full standby (left and right channels OFF), these resistors are disconnected (HiZ input).

5. With 4-layer PCB.



2 Typical application



Figure 1. Typical application schematics



Components	Functional description						
C_{S},C_{SL},C_{SR}	Supply capacitor that provides power supply filtering.						
C _{in}	Input coupling capacitors (optional) that block the DC voltage at the amplifier input terminal. The capacitors also form a high pass filter with Z_{in} ($F_{cl} = 1 / (2 \times \pi \times Z_{in} \times C_{in})$).						

Table 3. External component descriptions

Pin number	Pin name	Pin description
1	G1	Gain select pin (MSB)
2	Lout+	Left channel positive output
3	PVCC	Power supply
4	PGND	Power ground
5	Lout-	Left channel negative output
6	NC	No internal connection
7	STBYL	Standby pin (active low) for left channel output
8	STBYR	Standby pin (active low) for right channel output
9	AVCC	Analog supply
10	NC	No internal connection
11	Rout-	Right channel negative output
12	PGND	Power ground
13	PVCC	Power supply
14	Rout+	Right channel positive output
15	G0	Gain select pin (LSB)
16	Rin+	Right channel positive differential input
17	Rin-	Right channel negative differential input
18	AGND	Analog ground
19	Lin-	Left channel negative differential input
20	Lin+	Left channel positive differential input
	Thermal pad	Connect the thermal pad of the QFN package to PCB ground

Table 4. Pin descriptions



3 Electrical characteristics

3.1 Electrical characteristic tables

Table 5. V_{CC} = +5 V, GND = 0 V, V_{ic} = 2.5 V, T_{amb} = 25 °C
(unless otherwise specified)

Symbol	Parameters and test conditions	Min.	Тур.	Max.	Unit
I _{CC}	Supply current No input signal, no load, both channels		5	8	mA
I _{STBY}	Standby current No input signal, V _{STBY} = GND		0.2	2	μA
V _{oo}	Output offset voltage Floating inputs, G = 6dB, $R_L = 8\Omega$			25	mV
Po	Output power THD + N = 1 % max, f = 1 kHz, $R_L = 4 \Omega$ THD + N = 1 % max, f = 1 kHz, $R_L = 8 \Omega$ THD + N = 10 % max, f = 1 kHz, $R_L = 4 \Omega$ THD + N = 10 % max, f = 1 kHz, $R_L = 8 \Omega$		2.2 1.35 2.8 1.65		W
THD + N	Total harmonic distortion + noise $P_0 = 0.8 \text{ W}, \text{ G} = 6 \text{ dB}, \text{ f} = 1 \text{ kHz}, \text{ R}_L = 8 \Omega$		0.07		
Efficiency	Efficiency per channel $P_o = 2.2 \text{ W}, R_L = 4 \Omega + 15 \mu \text{H}$ $P_o = 1.25 \text{ W}, R_L = 8 \Omega + 15 \mu \text{H}$		81 89		%
PSRR	Power supply rejection ratio with inputs grounded $C_{in} = 1 \ \mu F^{(1)}$, f = 217 Hz, R _L = 8 Ω , Gain = 6 dB, $V_{ripple} = 200 \ mV_{pp}$		70		
Crosstalk	Channel separation $P_0 = 0.9 \text{ W}, \text{ G} = 6 \text{ dB}, \text{ f} = 1 \text{ kHz}, \text{ R}_L = 8 \Omega$		90		
CMRR	Common mode rejection ratio $C_{in} = 1 \ \mu\text{F}, f = 217 \ \text{Hz}, R_L = 8 \ \Omega, Gain = 6 \ \text{dB},$ $\Delta_{VICM} = 200 \ \text{mV}_{pp}$		70		dB
Gain		5.5 11.5 17.5 23.5	6 12 18 24	6.5 12.5 18.5 24.5	
Z _{in}	Single ended input impedance All gains, referred to ground	24	30	36	kΩ
F _{PWM}	Pulse width modulator base frequency	190	280	370	kHz
SNR	Signal to noise ratio (A-weighting) $P_0 = 1.3 \text{ W}, \text{ G} = 6 \text{ dB}, \text{ R}_L = 8 \Omega$		99		dB
t _{WU}	Wakeup time		1	3	ms
t _{STBY}	Standby time		1		



Symbol	Parameters and test conditions	Min.	Тур.	Max.	Unit
V _N	Output voltage noise f = 20 Hz to 20 kHz, $R_L=8 \Omega$ Unweighted (filterless, G = 6 dB) A-weighted (filterless, G = 6 dB) Unweighted (with LC output filter, G = 6 dB) A-weighted (with LC output filter, G = 6 dB) Unweighted (filterless, G = 24 dB) A-weighted (filterless, G = 24 dB) Unweighted (with LC output filter, G = 24 dB) A-weighted (with LC output filter, G = 24 dB)		63 35 60 35 115 72 109 71		μV _{RMS}

Table 5. V_{CC} = +5 V, GND = 0 V, V_{ic} = 2.5 V, T_{amb} = 25 °C (unless otherwise specified) (continued)

1. Dynamic measurements - $20*\log(rms(V_{out})/rms(V_{ripple}))$. V_{ripple} is the superimposed sinus signal to V_{CC} @ f = 217 Hz.



Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{CC}	Supply current No input signal, no load, both channels		3.3	6.5	mA
I _{STBY}	Standby current No input signal, V _{STBY} = GND		0.2	2	μA
V _{oo}	Output offset voltage Floating inputs, G = 6dB, $R_L = 8\Omega$			25	mV
Po	Output power THD + N = 1 % max, f = 1 kHz, $R_L = 4 \Omega$ THD + N = 1 % max, f = 1 kHz, $R_L = 8 \Omega$ THD + N = 10 % max, f = 1 kHz, $R_L = 4 \Omega$ THD + N = 10 % max, f = 1 kHz, $R_L = 8 \Omega$		1.15 0.68 1.3 0.9		W
THD + N	Total harmonic distortion + noise $P_0 = 0.4 \text{ W}, \text{ G} = 6 \text{ dB}, \text{ f} = 1 \text{ kHz}, \text{ R}_L = 8 \Omega$		0.05		
Efficiency	Efficiency per channel $P_o = 1.15 \text{ W}, R_L = 4 \Omega + 15 \mu H$ $P_o = 0.68 \text{ W}, R_L = 8 \Omega + 15 \mu H$		80 88		%
PSRR	Power supply rejection ratio with inputs grounded C_{in} = 1 µF ⁽¹⁾ , f = 217 Hz, R _L = 8 Ω, Gain = 6 dB, V_{ripple} = 200 mV _{pp}		70		
Crosstalk	Channel separation P _o = 0.5 W, G = 6 dB, f =1 kHz, R _L = 8 Ω		90		
CMRR	Common mode rejection ratio $C_{in} = 1 \ \mu\text{F}, f = 217 \ \text{Hz}, R_L = 8 \ \Omega, Gain = 6 \ \text{dB},$ $\Delta_{VICM} = 200 \ \text{mV}_{pp}$		70		dB
Gain		5.5 11.5 17.5 23.5	6 12 18 24	6.5 12.5 18.5 24.5	
Z _{in}	Single ended input impedance All gains, referred to ground	24	30	36	kΩ
F _{PWM}	Pulse width modulator base frequency	190	280	370	kHz
SNR	Signal to noise ratio (A-weighting) $P_0 = 0.65 \text{ W}, \text{ G} = 6 \text{ dB}, \text{ R}_L = 8 \Omega$		96		dB
t _{WU}	Wakeup time		1	3	me
t _{STBY}	Standby time		1		ms

Table 6. V_{CC} = +3.6 V, GND = 0 V, V_{ic} = 1.8 V, T_{amb} = 25 °C (unless otherwise specified)



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Symbol	Parameter	Min.	Тур.	Max.	Unit	
V _N	Output voltage noise f = 20 Hz to 20 kHz, $R_L = 4 \Omega$ Unweighted (filterless, G = 6 dB) A-weighted (filterless, G = 6 dB) Unweighted (with LC output filter, G = 6 dB) A-weighted (with LC output filter, G = 6 dB) Unweighted (filterless, G = 24 dB) A-weighted (filterless, G = 24 dB) Unweighted (with LC output filter, G = 24 dB) A-weighted (with LC output filter, G = 24 dB)		58 34 55 34 111 70 105 69		μV _{RMS}	

Table 6. V_{CC} = +3.6 V, GND = 0 V, V_{ic} = 1.8 V, T_{amb} = 25 °C (unless otherwise specified) (continued)

1. Dynamic measurements - $20*\log(rms(V_{out})/rms(V_{ripple}))$. V_{ripple} is the superimposed sinus signal to V_{CC} @ f = 217 Hz.





Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{CC}	Supply current No input signal, no load, both channels		2.8	4	mA
I _{STBY}	Standby current No input signal, V _{STBY} = GND		0.2	2	μA
V _{oo}	Output offset voltage Floating inputs, G = 6dB, $R_L = 8\Omega$			25	mV
Po	Output power THD + N = 1 % max, f = 1 kHz, $R_L = 4 \Omega$ THD + N = 1 % max, f = 1 kHz, $R_L = 8 \Omega$ THD + N = 10 % max, f = 1 kHz, $R_L = 4 \Omega$ THD + N = 10 % max, f = 1 kHz, $R_L = 8 \Omega$		0.53 0.32 0.75 0.45		W
THD + N	Total harmonic distortion + noise $P_0 = 0.2 \text{ W}, \text{ G} = 6 \text{ dB}, \text{ f} = 1 \text{ kHz}, \text{ R}_L = 8 \Omega$		0.04		
Efficiency	Efficiency per channel $P_o = 0.53 \text{ W}, R_L = 4 \Omega + 15 \mu \text{H}$ $P_o = 0.32 \text{ W}, R_L = 8 \Omega + 15 \mu \text{H}$		80 88		%
PSRR	Power supply rejection ratio with inputs grounded $C_{in} = 1 \ \mu F^{(1)}$, f = 217 Hz, R _L = 8 Ω , Gain = 6 dB, $V_{ripple} = 200 \ mV_{pp}$		70		
Crosstalk	Channel separation $P_0 = 0.2 \text{ W}, \text{ G} = 6 \text{ dB}, \text{ f} = 1 \text{ kHz}, \text{ R}_L = 8 \Omega$		90		
CMRR	Common mode rejection ratio $C_{in} = 1 \ \mu\text{F}, f = 217 \ \text{Hz}, R_L = 8 \ \Omega, Gain = 6 \ \text{dB},$ $\Delta_{VICM} = 200 \ \text{mV}_{pp}$		70		dB
Gain		5.5 11.5 17.5 23.5	6 12 18 24	6.5 12.5 18.5 24.5	
Z _{in}	Single ended input impedance All gains, referred to ground	24	30	36	kΩ
F _{PWM}	Pulse width modulator base frequency	190	280	370	kHz
SNR	Signal to noise ratio (A-weighting) $P_0 = 0.3 \text{ W}, \text{ G} = 6 \text{ dB}, \text{ R}_L = 8 \Omega$		93		dB
t _{WU}	Wakeup time		1	3	ms
t _{STBY}	Standby time		1		115

Table 7. V_{CC} = +2.5V, GND = 0V, V_{ic} =1.25V, T_{amb} = 25°C (unless otherwise specified)



(anoto operinda) (continued)							
Symbol	Parameter	Min.	Тур.	Max.	Unit		
V _N	Output voltage noise f = 20 Hz to 20 kHz, $R_L = 8 \Omega$ Unweighted (filterless, G = 6 dB) A-weighted (filterless, G = 6 dB) Unweighted (with LC output filter, G = 6 dB) A-weighted (with LC output filter, G = 6 dB) Unweighted (filterless, G = 24 dB) A-weighted (filterless, G = 24 dB) Unweighted (with LC output filter, G = 24 dB) A-weighted (with LC output filter, G = 24 dB)		57 34 54 33 110 71 104 69		μV _{RMS}		

Table 7. V_{CC} = +2.5V, GND = 0V, V_{ic}=1.25V, T_{amb} = 25°C (unless otherwise specified) (continued)

1. Dynamic measurements - 20*log(rms(V_{out})/rms(V_{ripple})). V_{ripple} is the superimposed sinus signal to V_{CC} @ f = 217 Hz.

3.2 Electrical characteristic curves

The graphs shown in this section use the following abbreviations:

- R_L + 15 µH or 30 µH = pure resistor + very low series resistance inductor
- Filter = LC output filter (1 μ F + 30 μ H for 4 Ω and 0.5 μ F + 60 μ H for 8 Ω)

All measurements are made with $C_{SL} = C_{SR} = 1 \ \mu\text{F}$ and $C_S = 100 \ n\text{F}$ (see *Figure 2*), except for the PSRR where $C_{SL,R}$ is removed (see *Figure 3*).











Figure 3. Test diagram for PSRR measurements

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6

5

4

3

2

1

0 L 2.5

Current Consumption (mA)

Figure 4. Current consumption vs. power supply voltage











Efficiency

0.10

0.15

Output Power (W)

0.20

Figure 7. Efficiency vs. output power (ii)





0.2

0.4

0.6

Output Power (W)

0.8

1.0

1.2

Figure 9. Efficiency vs. output power (iv)

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0.30

0.25



100

80

Efficiency (%) 09 09

20

0.00

0.05



3.0

2.5

2.0 1.5

1.0

0.5

0.0 └ 2.5

Output Power (W)

F = 1kHz

BW < 30kHz

Tamb = 25°C

3.0

THD+N=10%

3.5

Figure 10. Output power vs. power supply
voltage (i)Figure 10.3.5 $RL = 4\Omega + \ge 15\mu H$ 2.0

THD+N=1%

5.0

5.5

Figure 12. PSRR vs. common mode input voltage

4.0

Power Supply Voltage (V)

4.5



Figure 14. CMRR vs. common mode input voltage







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Figure 13. PSRR vs. frequency



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1 0.1 Output Power (W)

0.01





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2

1



Figure 30. THD+N vs. frequency (v)

















20

100

1k

Frequency (Hz)

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10k

20k

20

100

1k

Frequency (Hz)

20k

10k



Figure 42. Power derating curves



Figure 44. Startup and shutdown phase (ii)



Figure 41. Crosstalk vs. frequency (iv)

Figure 43. Startup and shutdown phase (i)



4 Application information

4.1 Differential configuration principle

The TS2012 is a monolithic fully-differential input/output class D power amplifier. The TS2012 also includes a common-mode feedback loop that controls the output bias value to average it at $V_{CC}/2$ for any DC common mode input voltage. This allows the device to always have a maximum output voltage swing, and by consequence, maximize the output power. Moreover, as the load is connected differentially compared with a single-ended topology, the output is four times higher for the same power supply voltage.

The **advantages** of a full-differential amplifier are:

- High PSRR (power supply rejection ratio)
- High common mode noise rejection
- Virtually zero pop without additional circuitry, giving a faster startup time compared with conventional single-ended input amplifiers
- Easier interfacing with differential output audio DAC
- No input coupling capacitors required thanks to common mode feedback loop

4.2 Gain settings

In the flat region of the frequency-response curve (no input coupling capacitor or internal feedback loop + load effect), the differential gain can be set to 6, 12 18, or 24 dB depending on the logic level of the G0 and G1 pins, as shown in *Table 9*.

Table 5. Gain Settings with 60 and 61 pins			
G1	G0	Gain (dB)	Gain (V/V)
0	0	6	2
0	1	12	4
1	0	18	8
1	1	24	16

Table 9. Gain settings with G0 and G1 pins

Note: Between pins G0, G1 and GND there is an internal 300 $k\Omega(\pm 20 \%)$ resistor. When the pins are floating, the gain is 6 dB. In full standby (left and right channels OFF), these resistors are disconnected (HiZ input).

4.3 Common mode feedback loop limitations

The common mode feedback loop allows the output DC bias voltage to be averaged at $V_{CC}/2$ for any DC common mode bias input voltage.

Due to the V_{ic} limitation of the input stage (see *Table 2: Operating conditions*), the common mode feedback loop can fulfill its role only within the defined range.



4.4 Low frequency response

If a low frequency bandwidth limitation is required, it is possible to use input coupling capacitors. In the low frequency region, the input coupling capacitor, C_{in} , starts to have an effect. C_{in} , with the input impedance Z_{in} , forms a first order, high-pass filter with a -3 dB cut-off frequency (see *Table 5* to *Table 7*) as shown in *Equation 1*:

Equation 1

$$F_{CL} = \frac{1}{2 \cdot \pi \cdot Z_{in} \cdot C_{in}}$$

So, for a desired cut-off frequency, F_{CL.} C_{in} is calculated as shown in *Equation 2*:

Equation 2

$$C_{in} = \frac{1}{2 \cdot \pi \cdot Z_{in} \cdot F_{CI}}$$

with F_{CL} in Hz, Z_{in} in Ω and C_{in} in F.

The input impedance Z_{in} is typically 30 k Ω for the whole power supply voltage range. There is also a tolerance around the typical value (see *Table 5* to *Table 7*). The maximum and minimum tolerance of the F_{CL} can be calculated using *Equation 3* and *Equation 4* respectively.

Equation 3

 $F_{CLmax} = 1.103 \cdot F_{CL}$

Equation 4

 $F_{CLmin} = 0.915 \cdot F_{CL}$

4.5 Decoupling of the circuit

Power supply capacitors, referred to as $C_S,\,C_{SL},\,\text{and}\,\,C_{SR}$ are needed to correctly bypass the TS2012.

The TS2012 has a typical switching frequency of 280 kHz and an output fall and rise time of about 5 ns. Due to these very fast transients, careful decoupling is mandatory.

A 1 μ F ceramic capacitor between each PVCC and PGND and also between AVCC and AGND is enough, but they must be located very close to the TS2012 in order to avoid any extra parasitic inductance created by a long track wire. Parasitic loop inductance, in relation to di/dt, introduces overvoltage that decreases the global efficiency of the device and may also cause a TS2012 breakdown if the parasitic inductance is too high.

In addition, even if a ceramic capacitor has an adequate high frequency ESR value, its current capability is also important. A 0603 size is a good compromise, particularly when a 4 Ω load is used.



Another important parameter is the rated voltage of the capacitor. A 1 μ F/6.3 V capacitor used at 5 V, loses about 50 % of its value. With a power supply voltage of 5 V, the decoupling value, instead of 1 μ F, could be reduced to 0.5 μ F. As C_S has particular influence on the THD+N in the medium to high frequency region, this capacitor variation becomes decisive. In addition, less decoupling means higher overshoots which can be problematic if they reach the power supply AMR value (6 V).

4.6 Wakeup time (t_{wu})

When standby is released to set the device ON, there is typically a delay of 1 ms. The TS2012 has an internal digital delay that mutes the outputs and releases them after this delay time to avoid any pop noise.

Note: The gain increases smoothly (see Figure 44) from the mute to the gain selected by the G1 and G0 pin (Section 4.2).

4.7 Shutdown time

When the standby command is set, the time required to set the output stage to high impedance and to put the internal circuitry in shutdown mode, is typically 1 ms. This time is used to decrease the gain and avoid any pop noise during shutdown.

Note: The gain decreases smoothly until the outputs are muted (see Figure 44).

4.8 Consumption in shutdown mode

Between the shutdown pin and GND there is an internal 300 k Ω (±20 %) resistor. This resistor forces the TS2012 to be in shutdown when the shutdown input is left floating.

However, this resistor also introduces additional shutdown power consumption if the shutdown pin voltage is not 0 V.

For example, with a 0.4 V shutdown voltage pin, the following typical and maximum values respectively for each shutdown pin must be added to the standby current specified in *Table 5* to *Table 7*: 0.4 V/300 k Ω = 1.3 µA and 0.4 V/240 k Ω = 1.66 µA. This current is provided by the external control device for standby pins.



4.9 Single-ended input configuration

It is possible to use the TS2012 in a single-ended input configuration. However, input coupling capacitors are mandatory in this configuration. The schematic diagram in *Figure 45* shows a typical single-ended input application.





4.10 Output filter considerations

The TS2012 is designed to operate without an output filter. However, due to very sharp transients on the TS2012 output, EMI radiated emissions may cause some standard compliance issues.

These EMI standard compliance issues can appear if the distance between the TS2012 outputs and the loudspeaker terminal are long (typically more than 50 mm or 100 mm, in both directions, to the speaker terminals). As the PCB layout and internal equipment device are different for each configuration, it is difficult to provide a one-size-fits-all solution.

However, to decrease the probability of EMI issues, the following simple rules should be followed:

- Reduce as much as possible the distance between the TS2012 output pins and the speaker terminals.
- Use a ground plane for "shielding" sensitive wires.
- Place, as close as possible to the TS2012 and in series with each output, a ferrite bead with a minimum rated current of 2.5 A and an impedance greater than 50 Ω at frequencies above 30 MHz. If, after testing, these ferrite beads are not necessary, replace them by a short-circuit.
- Allow extra footprint to place, if necessary, a capacitor to short perturbations to ground (see *Figure 46*).





If the distance between the TS2012 output and the speaker terminals is too long, it is possible to have low frequency EMI issues due to the fact that the typical operating frequency is 280 kHz. In this configuration, it is necessary to place the output filter shown in *Figure 1: Typical application schematics* as close as possible to the TS2012.



5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

5.1 QFN20 package information

The QFN20 package has an exposed pad E2 x D2. For enhanced thermal performance, the exposed pad must be soldered to a copper area on the PCB, acting as a heatsink. This copper area can be electrically connected to pin 4, 12, 18 (PGND, AGND) or left floating.



Figure 47. QFN20 package mechanical drawing

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		120 puonugo	meenamear	aata		
		nensions in mm		Dimensions in inches		
Ref Min	Тур	Max	Min	Тур	Max	
0.8	0.9	1	0.031	0.035	0.039	
	0.02	0.05		0.001	0.002	
	0.65	1		0.026	0.039	
	0.25			0.010		
0.18	0.23	0.3	0.007	0.009	0.012	
3.85	4	4.15	0.152	0.157	0.163	
	2.6			0.102		
3.85	4	4.15	0.152	0.157	0.163	
	2.6			0.102		
0.45	0.5	0.55	0.018	0.020	0.022	
0.3	0.4	0.5	0.012	0.016	0.020	
		0.08			0.003	
	Di Min 0.8 0.18 0.18 3.85 3.85 0.45	Dimensions in m Min Typ 0.8 0.9 0.02 0.02 0.65 0.25 0.18 0.23 3.85 4 2.6 3.85 3.85 4 0.45 0.5	Min Typ Max 0.8 0.9 1 0.8 0.9 1 0.8 0.9 1 0.65 1 0.25 1 0.18 0.23 0.3 3.85 4 4.15 2.6 3.85 4 4.15 0.45 0.5 0.55 0.3 0.4 0.5	Dimensions in mm Dimensions in mm Min Typ Max Min 0.8 0.9 1 0.031 0.8 0.9 1 0.031 0.65 1 0.02 0.05 0.18 0.23 0.3 0.007 3.85 4 4.15 0.152 2.6 2.6 1 1 0.45 0.5 0.55 0.018 0.45 0.5 0.55 0.012	Min Typ Max Min Typ 0.8 0.9 1 0.031 0.035 0.02 0.05 0.01 0.026 0.65 1 0.026 0.01 0.18 0.25 0.007 0.009 3.85 4 4.15 0.152 0.157 2.6 0.152 0.157 0.102 3.85 4 4.15 0.152 0.157 2.6 0.152 0.157 0.102 0.45 0.5 0.55 0.018 0.020 0.45 0.5 0.018 0.020 0.164	

Table 10. QFN20 package mechanical data

Figure 48. QFN20 footprint recommendation



Table 11. QFN20 footprint data

Ref.	Dimensions in mm	Dimensions in inches	
A	4.55	0.179	
В	4.55	0.179	
С	0.50	0.020	
D	0.35	0.014	
E	0.65	0.026	
F	2.45	0.096	
G	0.40	0.016	



6 Ordering information

Table 12. Order code

Part number	Temperature range	Package	Packaging	Marking
TS2012IQT	-40 °C to +85 °C	QFN20	Tape and reel	K012

7 Revision history

Date	Revision	Changes
17-Dec-2007	1	First release.
17-Jul-2013	2	Small text changes throughout document. Updated titles of <i>Figure 6</i> to <i>Figure 11</i> and <i>Figure 16</i> to <i>Figure 44</i> <i>Table 10: QFN20 package mechanical data</i> : added package mechanical dimensions in inches. Added <i>Table 11: QFN20 footprint data</i> <i>Table 12: Order code</i> ; updated "Marking"



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